

# P-Channel PowerTrench<sup>®</sup> MOSFET -40V, -50A, 12.3m $\Omega$

## Features

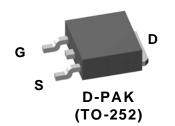
- Max  $r_{DS(on)}$  = 12.3m $\Omega$  at  $V_{GS}$  = -10V,  $I_D$  = -12.7A
- Max  $r_{DS(on)}$  = 18.0m $\Omega$  at V<sub>GS</sub> = -4.5V, I<sub>D</sub> = -10.4A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- RoHS Compliant

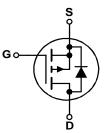
# **General Description**

This P-Channel MOSFET has been produced using Fairchild Semiconductor's proprietary PowerTrench<sup>®</sup> technology to deliver low  $r_{DS(on)}$  and optimized Bvdss capability to offer superior performance benefit in the applications. and optimized switching performance capability reducing power dissipation losses in converter/inverter applications.

## Applications

- Inverter
- Power Supplies





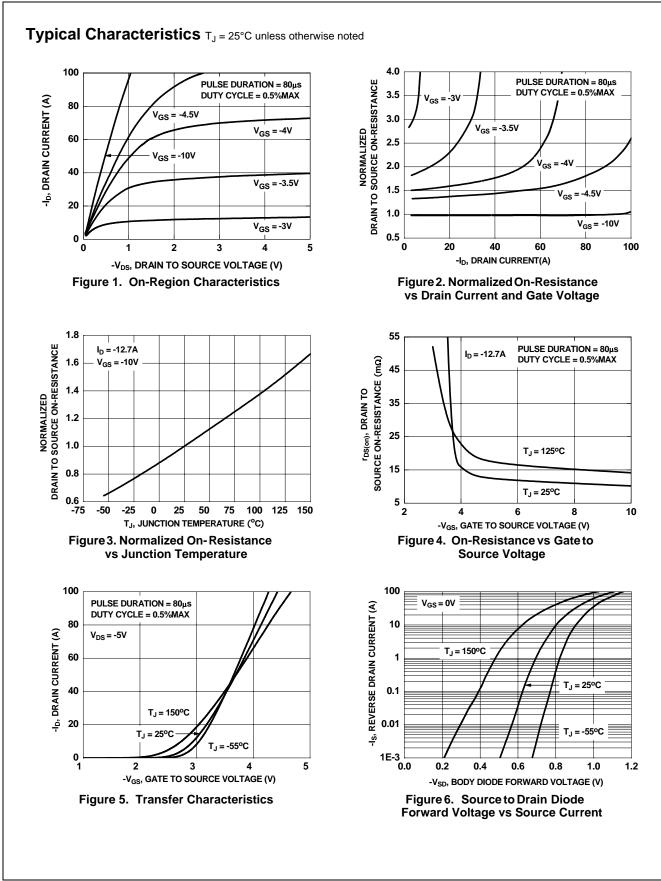
## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol		Parameter				Ratings		Units	
V <sub>DS</sub>	Drain to	Drain to Source Voltage				-40		V	
V <sub>GS</sub>	Gate to \$	Gate to Source Voltage			±20		V		
ID	Drain Current -Continuous (Package limited) T <sub>C</sub> = 25°C					-50			
	-Continuous (Silicon limited) $T_C = 25^{\circ}C$				-58		Α		
		-Continuous	T <sub>A</sub> =	25°C	(Note 1a)	-10.8	A		
	-Pulsed					-100			
E <sub>AS</sub>	Single P	Single Pulse Avalanche Energy (Note 3)		337		mJ			
P <sub>D</sub>	Power Dissipation			$T_{\rm C} = 25^{\circ}{\rm C}$		69		W	
	Power D	issipation	$T_{A} = 25^{\circ}C \qquad (N$			2.4	VV		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range				-55 to +150		°C		
Thermal Cl	haracteri	stics							
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case				1.8		°C/W		
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)					52			
	arking a	nd Ordering Informat	ion						
Device Marking		Device	Package	R	eel Size	Tape Width	Qua	Intity	
FDD4141		FDD4141	D-PAK (TO-252)		13"	16mm 2		2500 units	

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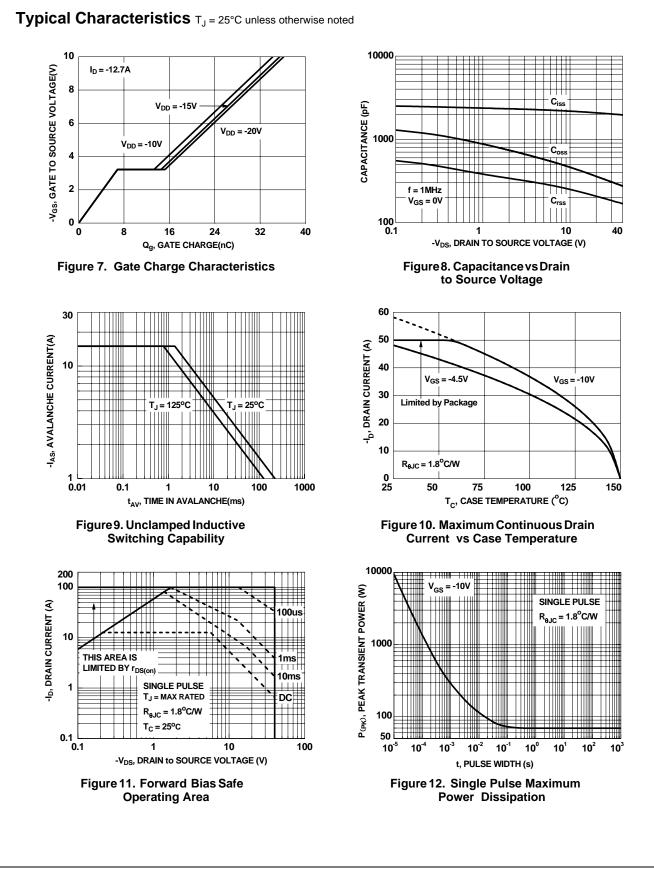
	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = -250μA, V <sub>GS</sub> = 0V	-40			V
ΔBV <sub>DSS</sub> ΔTJ	Breakdown Voltage Temperature	$I_D = -250\mu$ A, referenced to 25°C		-29		mV/°C
DSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -32V, V <sub>GS</sub> = 0V			-1	μA
	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
	cteristics	65 / 25	Į		ł	
			-1	10	-3	V
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \mu A$	-1	-1.8	-3	v
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Temperature Coefficient	$I_D = -250 \mu A$ , referenced to $25^{\circ}C$		5.8		mV/°C
		V <sub>GS</sub> = -10V, I <sub>D</sub> = -12.7A		10.1	12.3	- mΩ
	Static Drain to Source On Resistance	$V_{GS} = -4.5V, I_D = -10.4A$		14.5	18.0	
r <sub>DS(on)</sub>		V <sub>GS</sub> = -10V, I <sub>D</sub> = -12.7A, T <sub>J</sub> = 125°C		15.3	18.7	
JFS	Forward Transconductance	V <sub>DS</sub> = -5V, I <sub>D</sub> = -12.7A		38		S
-	Characteristics					
	Input Capacitance			2085	2775	pF
	Output Capacitance	$-V_{DS} = -20V, V_{GS} = 0V,$		360	480	pF
C <sub>oss</sub>	Reverse Transfer Capacitance	f = 1MHz		210	310	pF
ट <sub>rss</sub> २ <sub>g</sub>	Gate Resistance	f = 1MHz		4.6	510	Ω
•						
Switching	Characteristics				1	
d(on)	Turn-On Delay Time	V <sub>DD</sub> = -20V, I <sub>D</sub> = -12.7A,		10	19	ns
r	Rise Time	$-V_{GS} = -10V, R_{GEN} = 6\Omega$		7	13	ns
d(off)	Turn-Off Delay Time			38	60	ns
f	Fall Time			15	27	ns
ე <sup>g</sup>	Total Gate Charge	$V_{GS} = 0V \text{ to } -10V$		36	50	nC
Qg	Total Gate Charge	$V_{GS} = 0V \text{ to } -5V$ $V_{DD} = -20V,$ $I_{D} = -12.7A$		19	27	nC
Q <sub>gs</sub>	Gate to Source Charge	·D = ·2····		7		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			8		nC
Drain-Sou	arce Diode Characteristics					
√ <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_{S} = -12.7A$ (Note 2)		-0.8	-1.2	V
rr	Reverse Recovery Time	— I <sub>F</sub> = -12.7A, di/dt = 100A/μs		29	44	ns
ג גיי	Reverse Recovery Charge	F = -12.773, divat = 10077 µ3		26	40	nC

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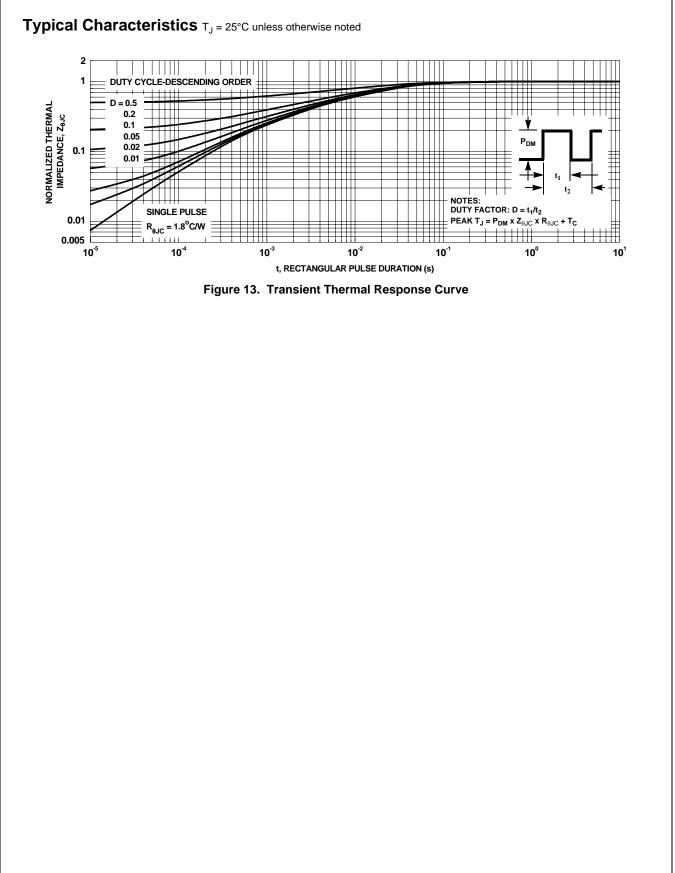
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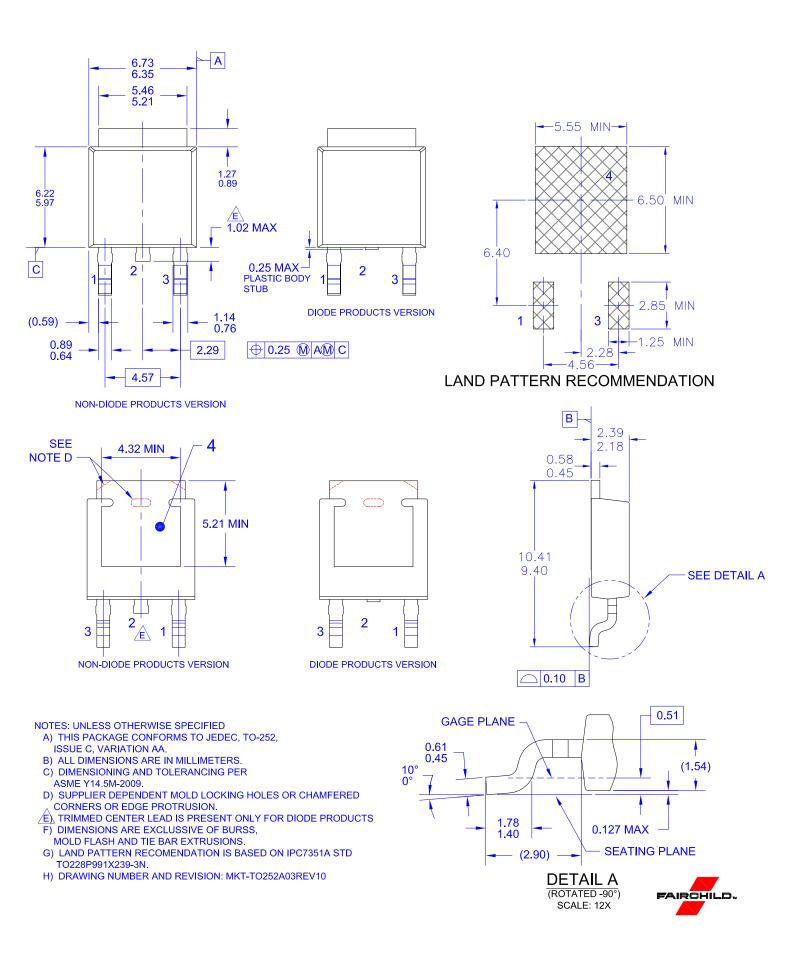
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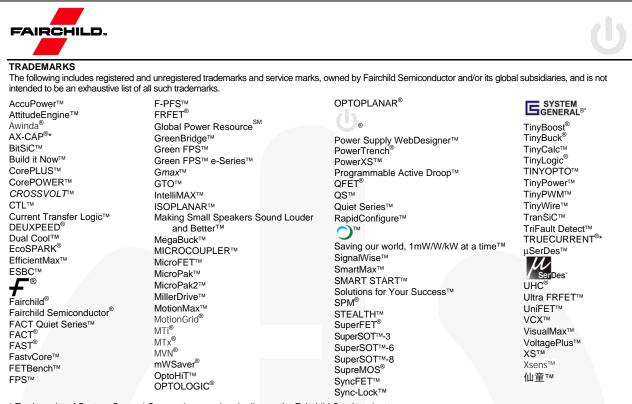
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5

FDD4141 P-Channel PowerTrench<sup>®</sup> MOSFET





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